

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Dongguk University	04/21/2008
RECEIVING PARTY DATA	
Name:	Dongguk University Industry Academic Cooperation Foundation
Street Address:	26, Pil-dong 3-ga, Jung-gu
City:	Seoul
State/Country:	REPUBLIC OF KOREA
Postal Code:	100-715
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11463474
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ATTORNEY DOCKET NUMBER:	45545.22.2
NAME OF SUBMITTER:	John F. Dolan
Total Attachments: 2 source=45545_22_2Assignment#page1.tif source=45545_22_2Assignment#page2.tif	

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PATENT
REEL: 020839 FRAME: 0693

ASSIGNMENT

WHEREAS, Dongguk University, having its principal offices at 26, 3-ga, Pildong, Dhung-gu, Seoul 100-715 Republic of Korea is the owner by Assignment of SUPER BRIGHT LIGHT EMITTING DIODE OF NANOROD ARRAY STRUCTURE HAVING InGaN QUANTUM WELL AND METHOD FOR MANUFACTURING SAME, for which a utility application is being made, said application which may be identified in the United States Patent Office by Application No. 11/463,474, filed August 9, 2006.

WHEREAS, Dongguk University Industry Academic Cooperation Foundation ("Assignee"), a corporation organized and existing under the laws of the Republic of Korea, and having its principal offices at 26, Pil-dong 3-ga, Jung-gu, Seoul 100-715 Republic of Korea, is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefore;

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable consideration to us in hand paid by said Assignee, the receipt of which is hereby acknowledged, we have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, our entire right, title and interest in and to said provisional or utility application, hereto including the inventions therein described and claimed and to each provisional and to any other application from which those applications claim priority in whole or in part including, but not limited to, all renewals, reissues, extensions, substitutions, continuations, continuations-in-part, or divisions thereof, or any other applications which claim any priority rights thereof; all foreign applications based thereon; all United States or foreign Letters Patents which may issue with respect to such applications and we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned Assignee in accordance herewith; all rights to enforce patent rights to such applications and Letters Patents as fully and entirely as the same would have been held and enjoyed by the Assignor if this assignment had not been made; together with all claims by Assignor for damages by reason of past infringement or for provisional rights and including the right to sue for, and collect the same for its own use and benefit, and for the use and benefit of its successors, assigns, and other legal representatives.

We hereby authorize the above mentioned Assignee, its successors and assigns, or anyone it may properly designate, to insert in this instrument the filing date and application number of said application when ascertained.

We further authorize said Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of the International Convention.

Upon said consideration we do hereby covenant and agree with the said Assignee, its successors and assigns, that we will not execute in writing or do any act whatsoever conflicting with these presents, and that we or our executors or administrators will at any time

upon request, without further or additional consideration, but at the expense of the said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

IN WITNESS WHEREOF, we have hereunto set our hands and affixed our seal as dated below.

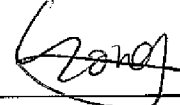
Date: 2008. 4. 21



IM, Yong-Taek, The Chancellor of the Board
of Directors, Dongguk University Foundation

STATEMENT BY WITNESS FOR: YONG-TAEK IM

I, Mr-Ban Song whose full post office address is: 26, Pil-dong 3-ga, Jung-gu, Seoul 100-715 Republic of Korea was personally present and did see YONG-TAEK IM, who is known to me, execute the above assignment.



(Signature of Witness)